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(12) **United States Design Patent**
Du

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- (54) **EARPHONE**
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- (**) Term: **15 Years**
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(Continued)

(30) **Foreign Application Priority Data**

Sep. 18, 2020 (EM) 008173108-0007

- (51) **LOC (14) Cl.** **14-01**
- (52) **U.S. Cl.**
USPC **D14/223**
- (58) **Field of Classification Search**
USPC D14/223, 205; D24/174; 128/864-866;
381/380-381
CPC H04R 1/10; H04R 25/00; H04R 25/02;
H04R 1/1066; H04R 1/1016; H04R
5/0335; H04R 5/033; H04R 1/1083;
H04R 1/1091
See application file for complete search history.

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Primary Examiner — Paula Allen Greene

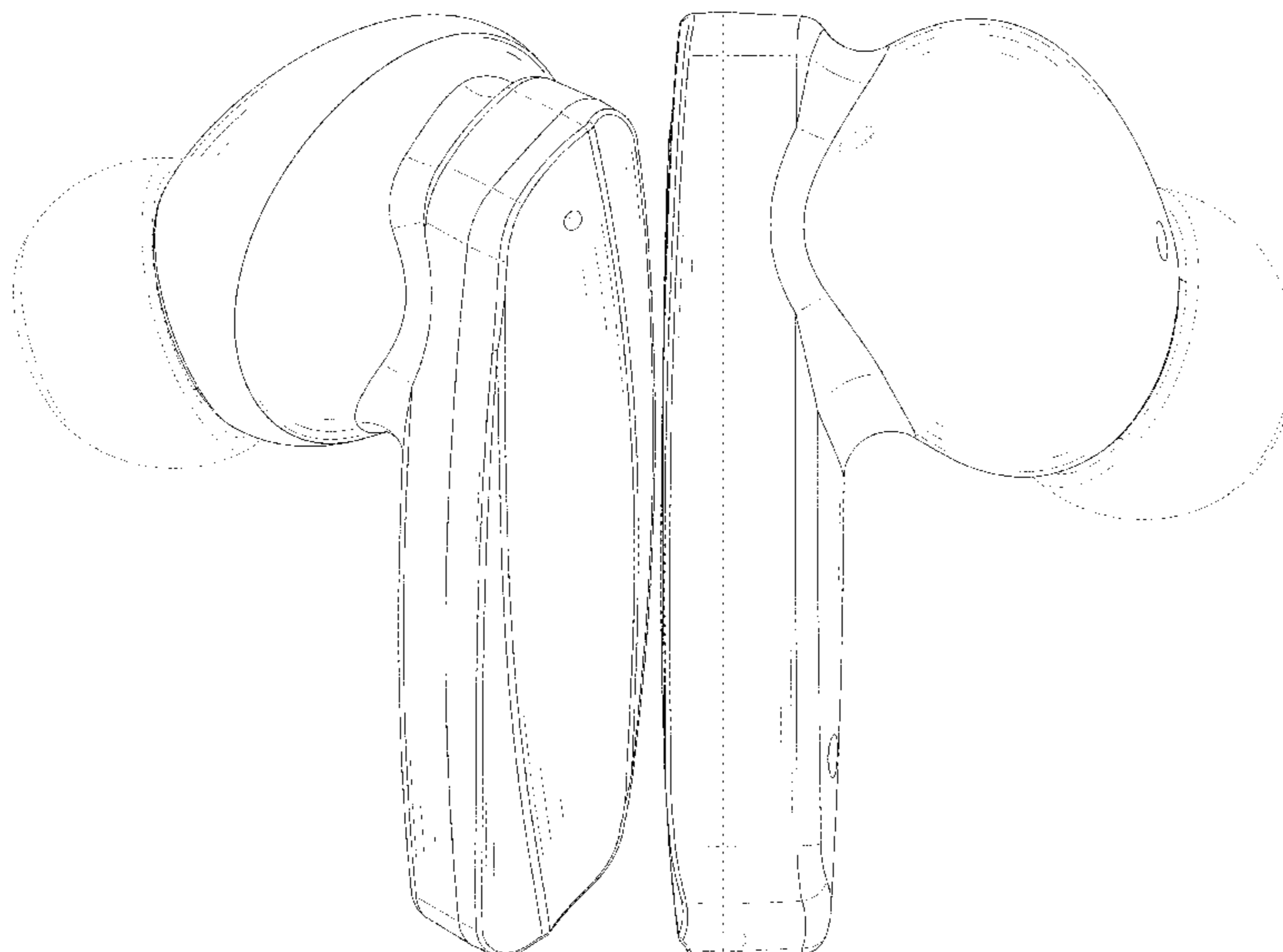
(57) **CLAIM**

The ornamental design for an earphone, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of an earphone showing my new design;
 FIG. 2 is another perspective view thereof;
 FIG. 3 is a front elevational view thereof;
 FIG. 4 is a rear elevational view thereof;
 FIG. 5 is a left side elevational view thereof;
 FIG. 6 is a right side elevational view thereof;
 FIG. 7 is a top plan view thereof; and,
 FIG. 8 is a bottom plan view thereof.
 The broken lines in the drawings depict portions of the earphone that form no part of the claimed design.

1 Claim, 8 Drawing Sheets



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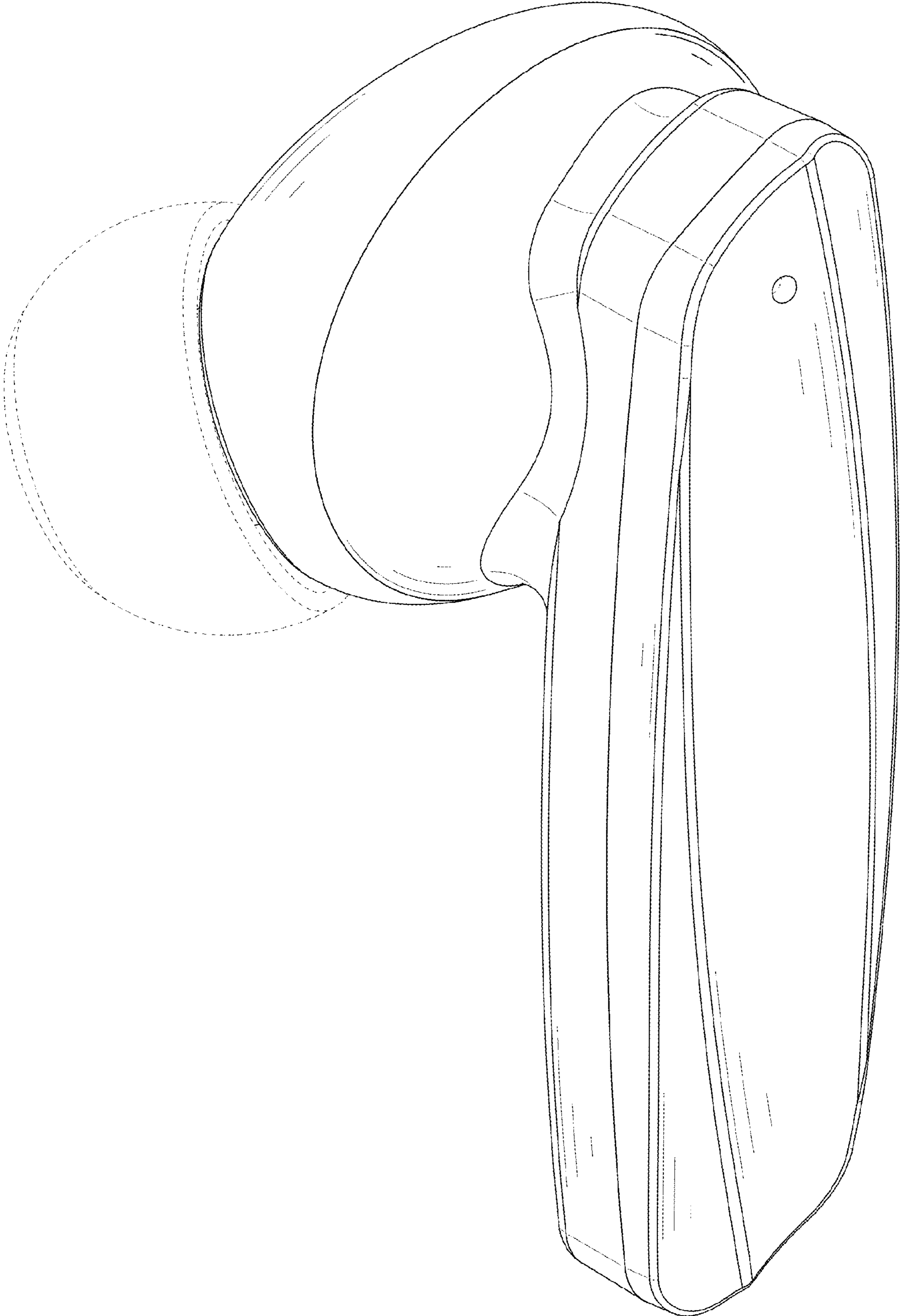


FIG. 1

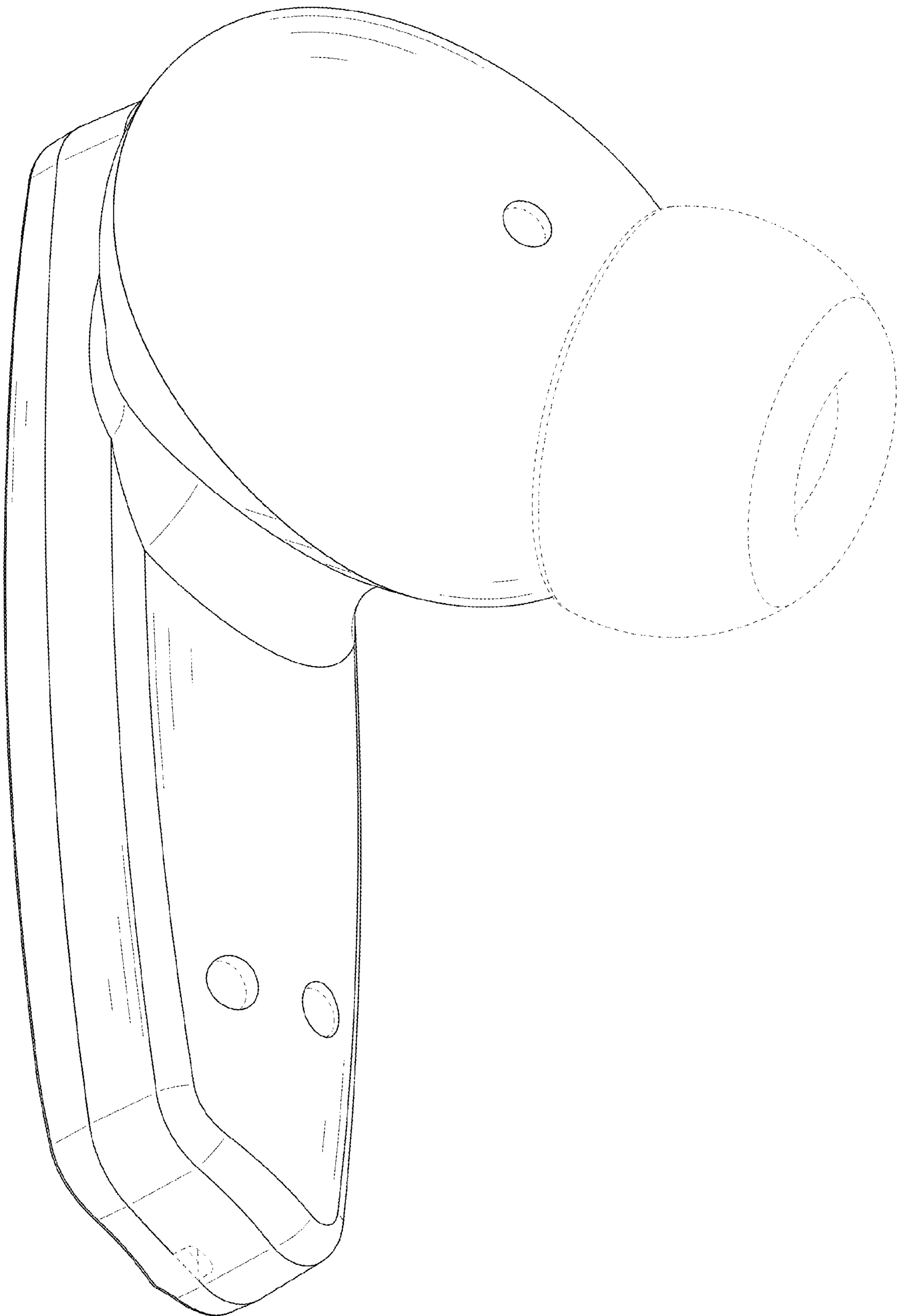


FIG. 2



FIG. 3

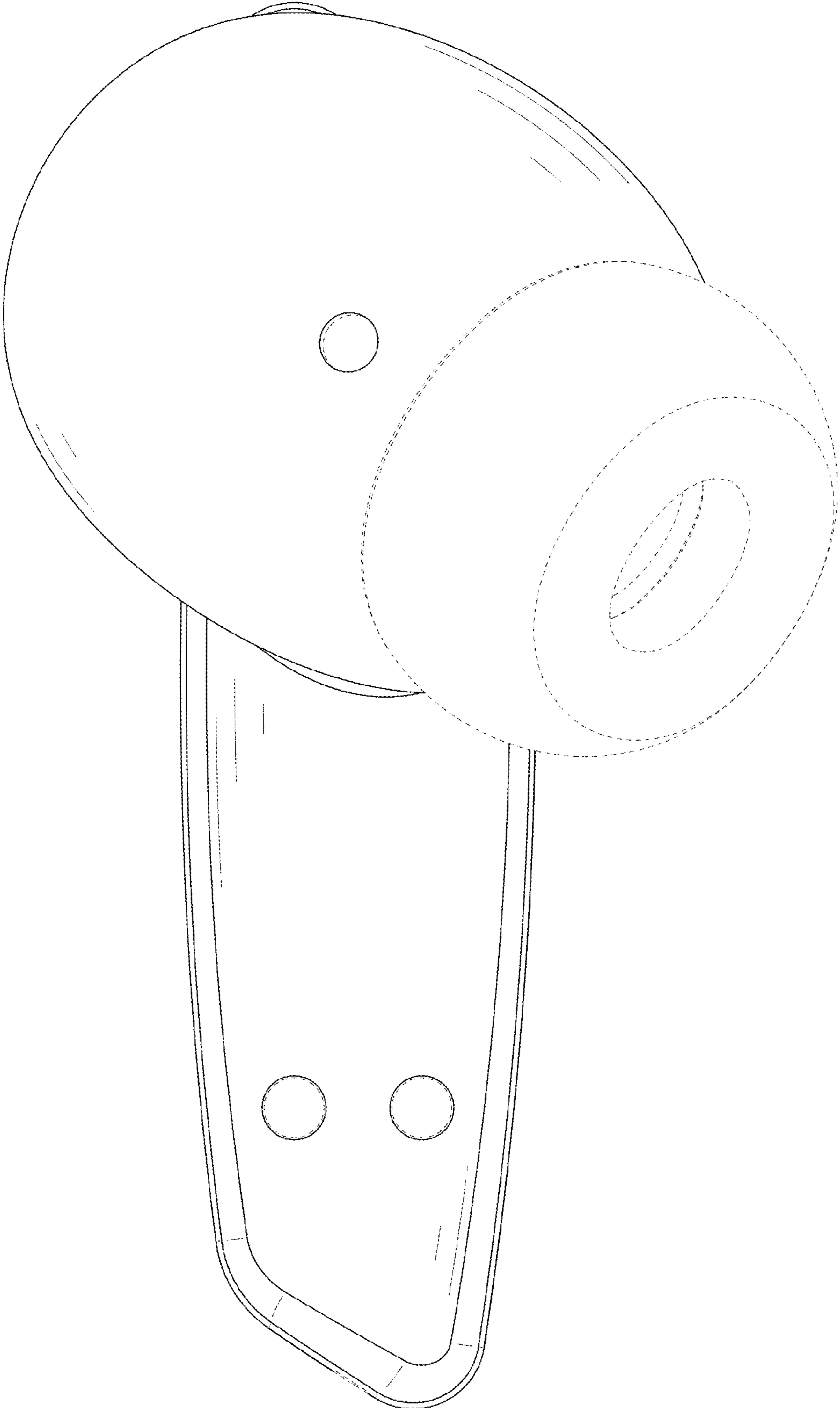


FIG. 4

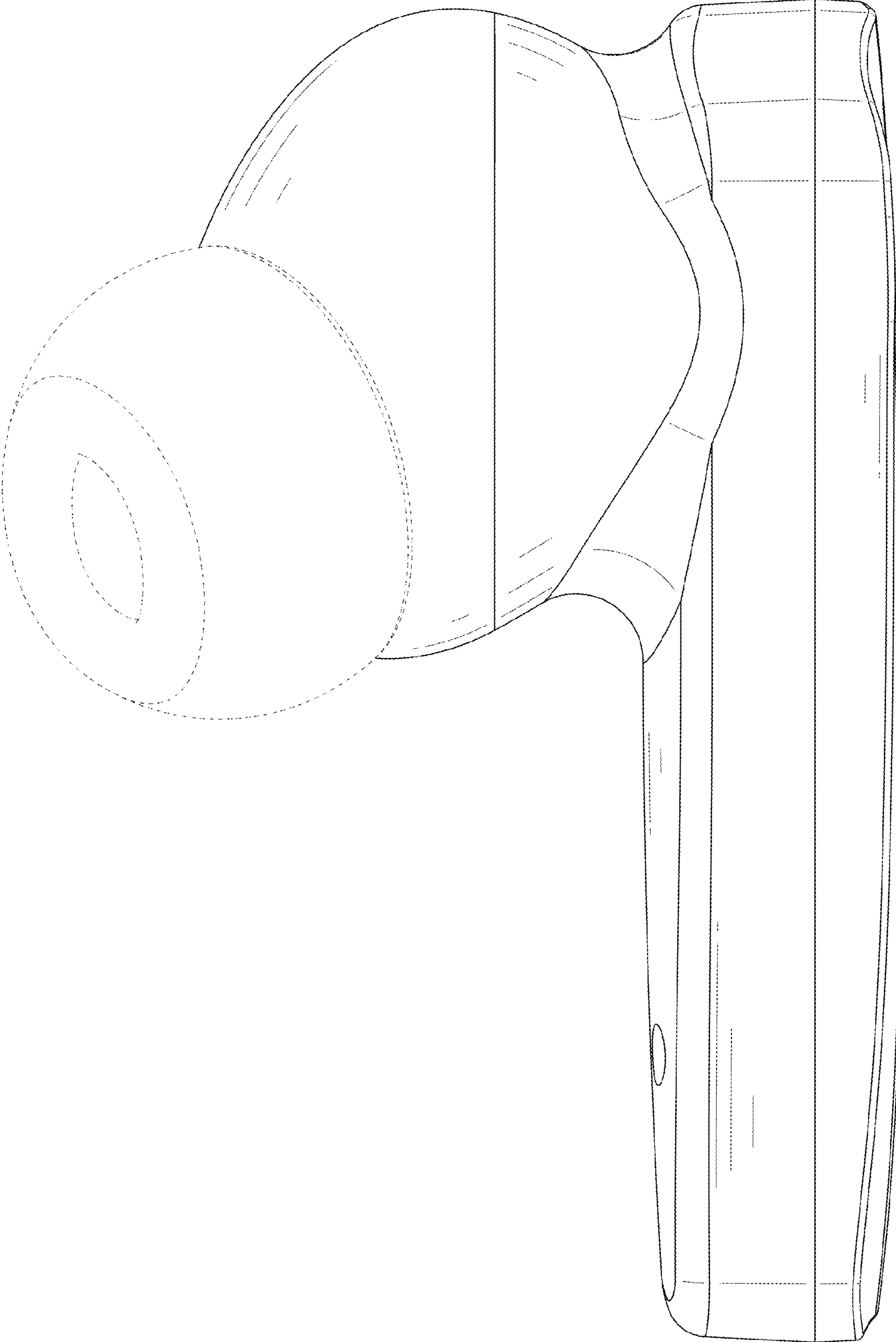


FIG. 5

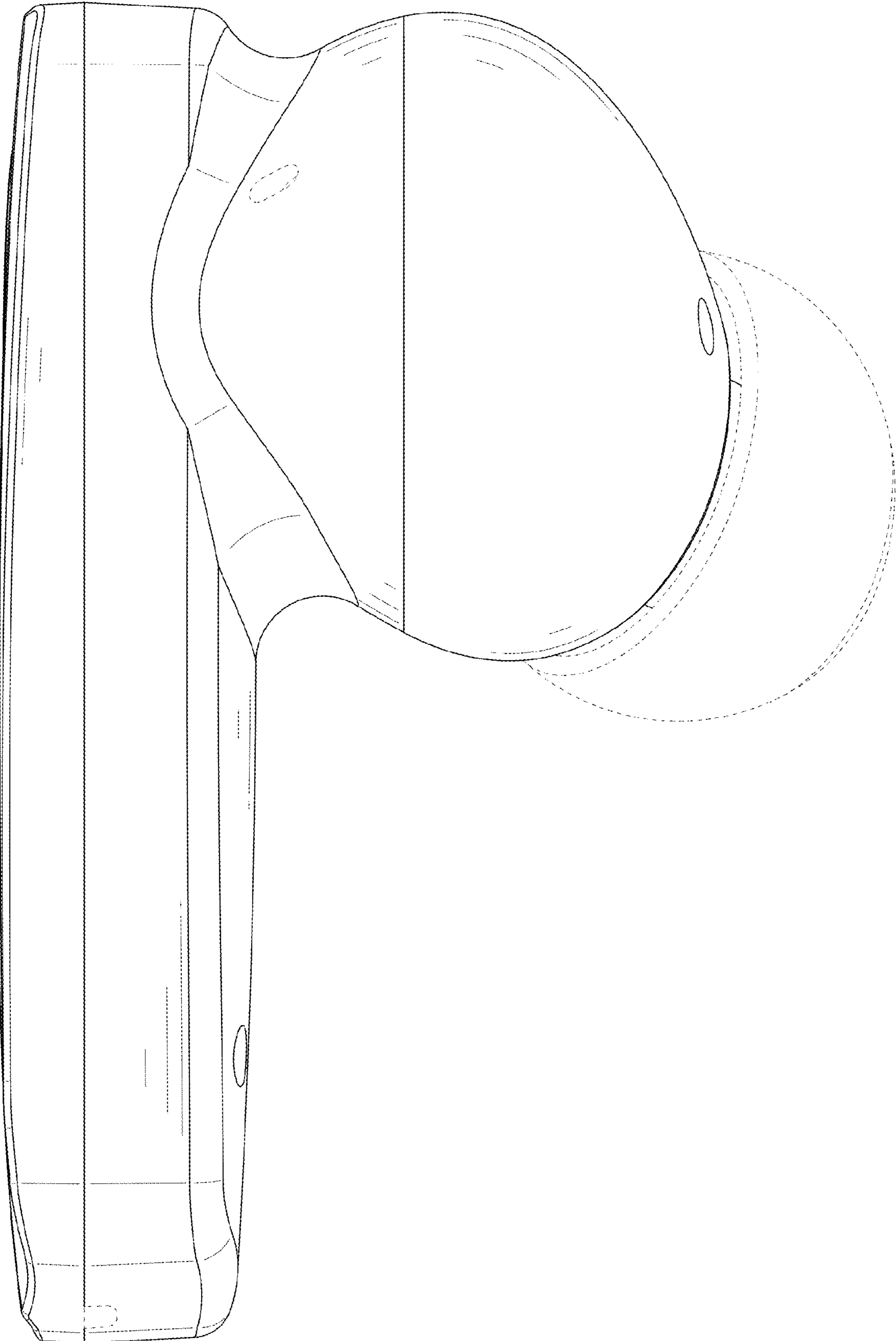


FIG. 6

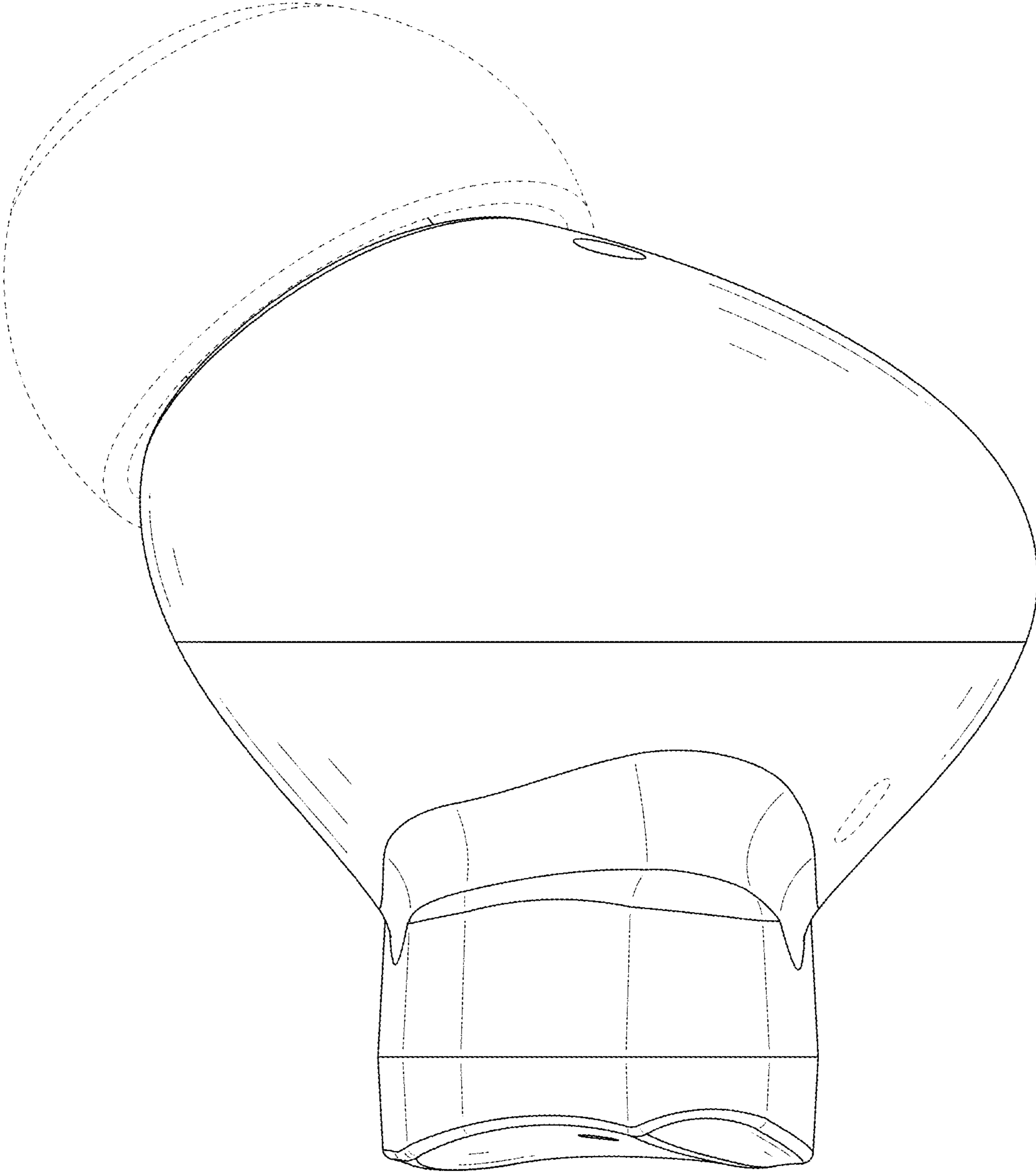


FIG. 7

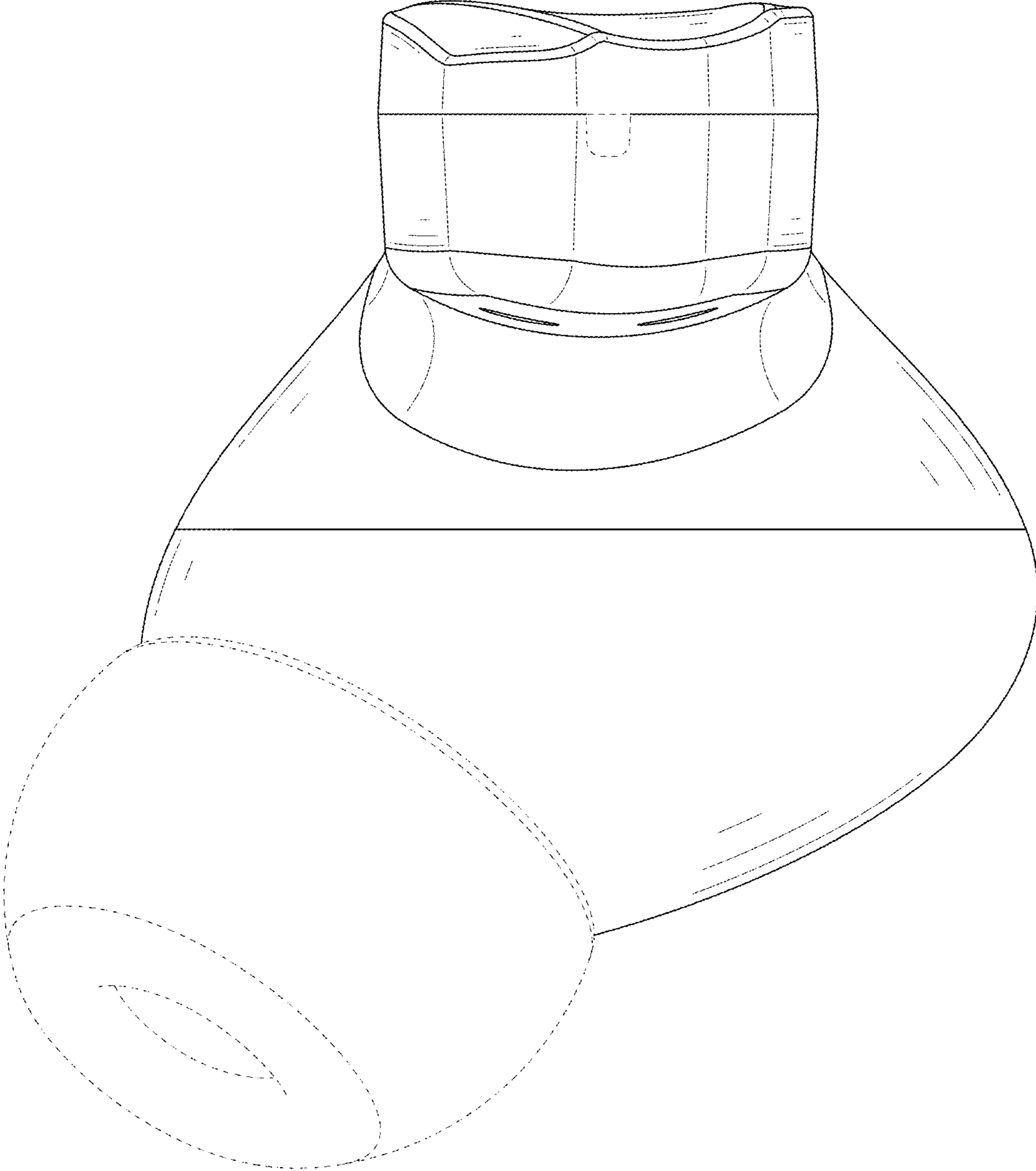


FIG. 8